Vishay Siliconix

N-Channel 100 V (D-S) MOSFET

SOT-23 (TO-236)



Marking code: G2

FEATURES

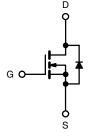
- TrenchFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- DC/DC converters / boost converters
- · Load switch
- · LED backlighting in LCD TVs
- · Power management for mobile computing



N-Channel MOSFET

ORDERING INFORMATION				
Package	SOT-23			
Lead (Pb)-free and halogen-free	Si2392ADS-T1-GE3			

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage	V_{DS}	100	V	
Gate-source voltage	V_{GS}	± 20	v	
	T _C = 25 °C		3.1	
Continuo durin august (T. 150 °C)	T _C = 70 °C	,	2.5	
Continuous drain current (T _J = 150 °C)	T _A = 25 °C	I _D	2.2 b, c	
	T _A = 70 °C		1.8 ^{b, c}	
Pulsed drain current (t = 300 μs)	I _{DM}	8	_ A	
Continuous source-drain diode current	T _C = 25 °C	I _S	2.1	
	T _A = 25 °C		1 b, c	
Single pulse avalanche current	. 0.411	I _{AS}	3	
Single pulse avalanche energy	L = 0.1 mH	E _{AS}	0.45	mJ
Maximum power dissipation	T _C = 25 °C	P _D	2.5	
	T _C = 70 °C		1.6	٦ ,,,
	T _A = 25 °C		1.25 ^{b, c}	W
	T _A = 70 °C		0.8 b, c	
Operating junction and storage temperature range	T _J , T _{stq}	-55 to +150	°C	

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 5 s	R _{thJA}	75	100	°C/W	
Maximum junction-to-foot (drain)	Steady state	R_{thJF}	40	50	C/VV	

Notes

- a. Based on $T_C = 25~^{\circ}C$
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 5 s
- d. Maximum under steady state conditions is 166 °C/W

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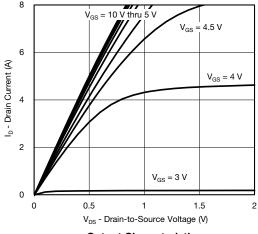
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	1				l	•	
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	100	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 A	-	59	-		
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu\text{A}$		-4.8	-	mV/°C	
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2	-	3	V	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zono della collega della consul		V _{DS} = 100 V, V _{GS} = 0 V	-	-	1		
Zero gate voltage drain current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 55 °C		10	μA		
On-state drain current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	5	-	-	Α	
) /	V _{GS} = 10 V, I _D = 2 A	-	0.102	0.126		
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 6 \text{ V}, I_D = 1 \text{ A}$	-	0.120	0.144	Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 1 \text{ A}$	-	0.135	0.189		
Forward transconductance ^a	9 _{fs}	$V_{DS} = 20 \text{ V}, I_{D} = 2 \text{ A}$	-	5	-	S	
Dynamic ^b	.				l	•	
Input capacitance	C _{iss}		-	196	-	pF	
Output capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	67	-		
Reverse transfer capacitance	C _{rss}		-	14	-		
Total gate charge		$V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 2.2 \text{ A}$	-	5.2	10.4	4	
	Qg		-	2.9	5.8	nC	
Gate-source charge	Q _{gs}	$V_{DS} = 50 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 2.2 \text{ A}$	-	1	-		
Gate-drain charge	Q _{qd}		-	1.4	-		
Gate resistance	R_g	f = 1 MHz	0.9	4.3	8.6	Ω	
Turn-on delay time	t _{d(on)}		-	40	60		
Rise time	t _r	$V_{DD} = 50 \text{ V}, R_1 = 27.7 \Omega$	-	68	102		
Turn-off delay time	t _{d(off)}	$I_D = 1.8 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$	-	14	21	1	
Fall time	t _f		-	20	30	1	
Turn-on delay time	t _{d(on)}		-	8	16	ns	
Rise time	t _r	$V_{DD} = 50 \text{ V}, R_1 = 27.7 \Omega$	-	10	20	1	
Turn-off delay time	t _{d(off)}	$I_D = 1.8 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$	-	10	20		
Fall time	t _f		-	7	14	1	
Drain-Source Body Diode Characteristi	cs						
Continuous source-drain diode current	Is	T _C = 25 °C	-	-	2.1	^	
Pulse diode forward current ^a	I _{SM}		-	-	8	A	
Body diode voltage	V _{SD}	I _S = 1.8 A	-	0.8	1.2	V	
Body diode reverse recovery time	t _{rr}		-	23	35	ns	
Body diode reverse recovery charge	Q _{rr}	$I_F = 1.8 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	21	32	nC	
Reverse recovery fall time	ta	T _J = 25 °C	-	17	-		
Reverse recovery rise time	t _b		_	6	_	ns	

Notes

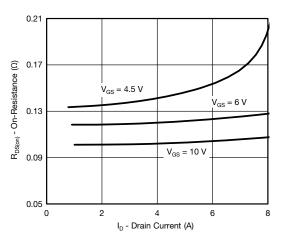
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

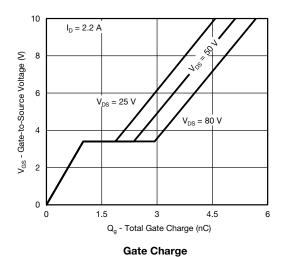


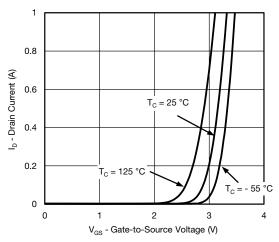


Output Characteristics

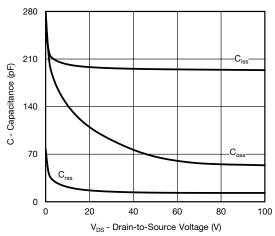


On-Resistance vs. Drain Current and Gate Voltage

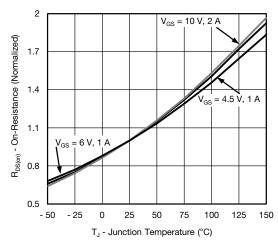




Transfer Characteristics

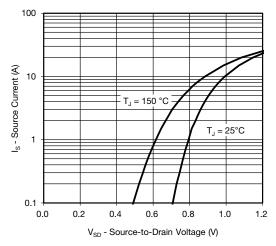


Capacitance

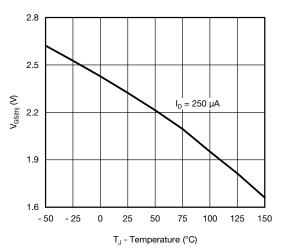


On-Resistance vs. Junction Temperature

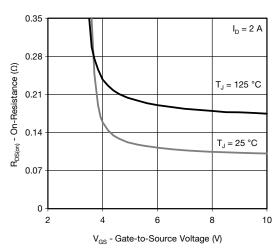




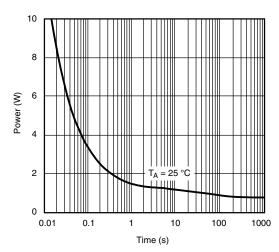
Source-Drain Diode Forward Voltage



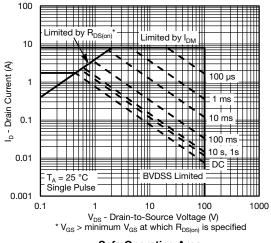
Threshold Voltage



On-Resistance vs. Gate-to-Source Voltage

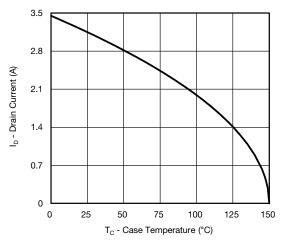


Single Pulse Power

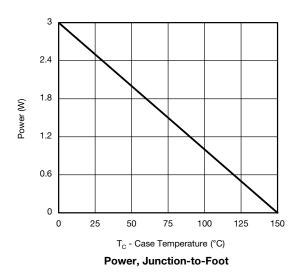


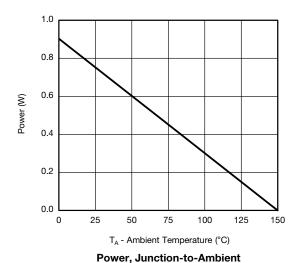
Safe Operating Area





Current Derating a

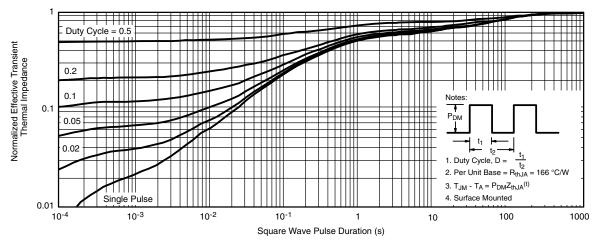




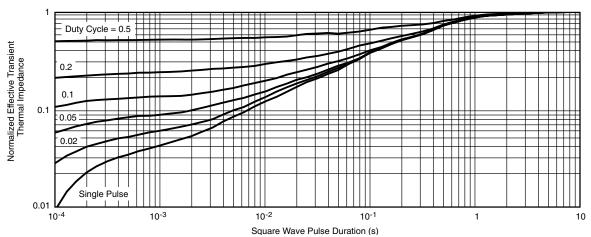
Note

a. The power dissipation P_D is based on T_J max.= 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient

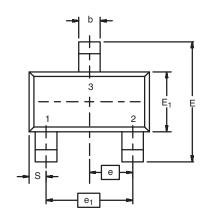


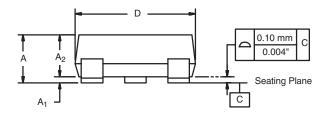
Normalized Thermal Transient Impedance, Junction-to-Foot

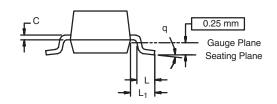
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SOT-23 (TO-236): 3-LEAD







Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.9	5 BSC	0.0374 Ref		
e ₁	1.9	1.90 BSC		8 Ref	
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
FCN: S-03946-Rev K 09-	lul-01	•			

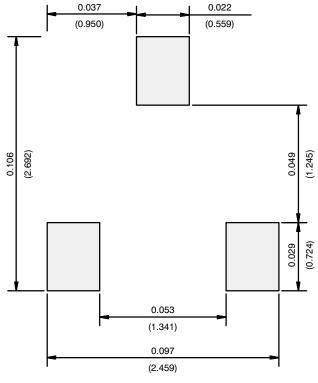
ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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